

L Number	Hits	Search Text	DB	Time stamp
1	2	65/374.11.cccls. and (palstic or polyacetal or electrostatic or dissipative)	USPAT	2002/11/02 17:56
2	11	83/\$.cccls. and (semiconductor) and(palstic or polyacetal or electrostatic or dissipative)	USPAT	2002/11/02 18:03
3	352	(65/61).CCLS.	USPAT	2002/11/02 18:05
4	247	83/\$.cccls. and (semiconductor)	USPAT	2002/11/02 18:12
5	82	41 and (break\$ and tool)	USPAT	2002/11/02 18:12
6	10	41 and (break\$ with edge)	USPAT	2002/11/02 18:14
8	121	41 and (gauge)	USPAT	2002/11/02 18:19
9	547	(225/103).CCLS.	USPAT	2002/11/02 18:20
10	113	225/103.cccls. and (glass or semiconductor or chip)	USPAT; EPO; JPO; DERWENT; IBM TDB	2002/11/02 18:40
11	16	225/105.cccls. and (glass or semiconductor or chip) not (225/103.cccls. and (glass or semiconductor or chip))	USPAT; EPO; JPO; DERWENT; IBM TDB	2002/11/02 18:41